



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: YOSHIDA, AKITO DOCKET NO.: W2K1077
SERIAL NO: 10/082, 472 EXAMINER: ZARNEKE
FILED: 02/22/2002 ART UNIT: 2827
TITLE: A STACKING STRUCTURE FOR SEMICONDUCTOR DEVICES
USING A FOLDED OVER FLEXIBLE SUBSTRATE AND METHOD
THEREFOR

Commissioner for Patents Weiss, Moy & Harris, P.C.
P.O. Box 1450 4204 N. Brown Avenue
Alexandria, VA 22313-1450 Scottsdale, AZ 85251-3989

August 6, 2003

I hereby certify that on the 6th day of August, 2003,
this correspondence is being deposited with the U.S.
Postal Service as first class mail in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450
Alexandria, VA 22313-1450.



Jeffrey D. Moy

AMENDMENT

Dear Sir:

This is in response to the Office Action dated May 6,
2003 in regards to the above identified patent application. Please
amend the subject patent application as follows: